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Complete housing for Raspberry Pi printed-circuit boards. Includes housing half shells, side panels with openings for all relevant connections, adhesive pads for affixing the Raspberry Pi model B4 computers, screws for housing and PCB attachment; light gray housing with turquoise-blue corner inlays

Your advantages

- High degree of application flexibility, thanks to the modular housing design
- Flexible PCB attachment, adapts to virtually all form factors
- ☑ Practical customization options
- Reduced logistics outlay, thanks to components which are compatible with one another
- Delivery as a complete housing with ready-machined side panels



Key Commercial Data

Packing unit	1 pc
GTIN	4 063151 571658
GTIN	4063151571658
Custom tariff number	84879090

Technical data

Item properties

Туре	UCS-KIT-145-125-RPI4B-9005
Item no.	1311027
Housing type	Universal housings
Туре	Flat design
Max. IP code to attain	IP20
Ventilation openings present	no

Measurements

Caption	Schematic representation – for additional information, see product range drawing in the Download Center
Width [w]	145 mm



Technical data

Measurements

Height [h]	125 mm
Depth [d]	47 mm

Material specifications

Housing material	PC
Surface characteristics	untreated
Color (RAL)	black (9005)
Flammability rating according to UL 94	V0

Ambient conditions

Ambient temperature (storage/transport)	-40 °C 55 °C
Ambient temperature (assembly)	-5 °C 100 °C
Ambient temperature (operation)	-40 °C 105 °C (depending on power dissipation)
Relative humidity (storage/transport)	80 %

PCB data

Number of PCB holders	1
Note on PCB holders	This product is prepared for a printed-circuit board. Additional printed-circuit boards can be mounted using adhesive pads (accessories).
Total PCB surface	12000 mm²
Type of PCB mount	Bolt mounting
Supported form factors	Raspberry Pi

Power dissipation, single housing at 20°C

Ambient temperature	20 °C
Reduction factor	1
Mounting position	vertical
Power dissipation	11 W

Power dissipation, single housing at 30 °C

Ambient temperature	30 °C
Reduction factor	0.85
Mounting position	vertical
Power dissipation	9.4 W

Power dissipation, single housing at 40 °C

Ambient temperature	40 °C
Reduction factor	0.7
Mounting position	vertical
Power dissipation	7.7 W

Power dissipation, single housing at 50 °C

Ambient temperature	50 °C
Reduction factor	0.55
Mounting position	vertical



Technical data

Power dissipation, single housing at 50 °C

Power dissipation	6 W
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Power dissipation, single housing at 60 °C

Ambient temperature	60 °C
Reduction factor	0.4
Mounting position	vertical
Power dissipation	4.4 W

Mechanical strength/tumbling barrel

Specification	IEC 60068-2-31:2008-05
Height of fall	50 cm
Number of drop cycles	50

Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.15 mm (10 - 58.1 Hz)
Acceleration	2g (58.1 - 150 Hz)
Test duration per axis	2.5 h
Test directions	X-, Y- and Z-axis

Shock

Specification	IEC 60068-2-27:2008-02
Pulse shape	Half-sine
Acceleration	15g
Shock duration	11 ms
Number of shocks per direction	3
Test directions	X-, Y- and Z-axis (pos. and neg.)

Thermostability (ball thrust test)

Specification	IEC 60695-10-2:2014-02
Temperature	125 °C
Test duration	1 h
Force	20 N

Test for assessing the risk of fire (glow wire)

Specification	DIN EN 60695-2-11 (VDE 0471-2-11):2014-11
Temperature	850 °C
Time of exposure	30 s

Test for substances that would hinder coating with paint or varnish

Result	Test passed
Specification	VW PV 3.10.7:2005-02



Technical data

Degrees of protection provided by enclosures (IP code)

Specification	IEC 60529:1989-11 + AMD 1:1999-11 + AMD 2:2013-08
Result, degree of protection, IP code	IP20

General information

Note	The housing can be opened a maximum of 10 times.
	Attach the adhesive pads: Make sure that the surface of the housing is clean, dry, and free of grease. Temperature range: +18°C +30°C / Closing pressure force: 60 N / Closing pressure time: 3 s
	Refer to the data sheet for the range in the download area.

Note on mounting

Tightening torque / rotational speed	Screw connection between housing halves: 1.2 Nm-1.4 Nm / 500 rpm-1000 rpm
	Mounting the PCB: 0.4 Nm-0.5 Nm / 500 rpm-1000 rpm
Drive form screw head	Screw connection between housing halves: Slotted Torx®(T10)
	Mounting the PCB: Slotted Torx®(T7)

Packaging information

Type of packaging	Box packaging
Pieces per package	1
Denomination packing units	Pcs.

Standards and regulations

Flammability rating according to UL 94	V0

Drawings

Dimensional drawing



Schematic representation – for additional information, see product range drawing in the Download Center

Classifications

eCl@ss

eCl@ss 10.0.1	27182702
eCl@ss 11.0	27182702
eCl@ss 9.0	27182702

Approvals

Approvals



Approvals		
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UL Recognized		
Ex Approvals		
Approval details		
UL Recognized	http://database.ul.com/cgi-bin/XYV/template/LISEXT/1FRAME/index.htm	FILE E 240868

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